

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

Fast Thyristor Type **FDT56-630-36**

Low switching losses
Distributed amplified gate for high di_T/dt

Mean on-state current		I_{TAV}	630 A	
Repetitive peak off-state voltage		V_{DRM}	3000...3600 V	
Repetitive peak reverse voltage		V_{RRM}		
Turn-off time		t_q	50.0, 63.0 μ s	
V_{DRM}, V_{RRM}, V	3000	3200	3400	3600
Voltage code	30	32	34	36
$T_j, ^\circ C$	-60...+125			

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
ON-STATE				
I_{TAV}	Mean on-state current	A	630 705 1035	$T_c = 90^\circ C$; Double side cooled; $T_c = 85^\circ C$; Double side cooled; $T_c = 55^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz
I_{TRMS}	RMS on-state current	A	989	$T_c = 90^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz
I_{TSM}	Surge on-state current	kA	17.0 20.0	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 1$ A/ μ s
			18.0 21.0	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 1$ A/ μ s
I^2t	Safety factor	$A^2s \cdot 10^3$	1400 2000	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 1$ A/ μ s
			1300 1800	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 1$ A/ μ s
BLOCKING				
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	3000...3600	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; Gate open
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3100...3700	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; single pulse; Gate open
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j = T_{jmax}$; Gate open

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

TRIGGERING				
I_{FGM}	Peak forward gate current	A	8	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ μ s	2000	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 6400$ A; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60...+50	
T_j	Operating junction temperature	$^{\circ}$ C	-60...+125	
MECHANICAL				
F	Mounting force	kN	24.0...28.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	2.80	$T_j = 25$ $^{\circ}$ C; $I_{TM} = 1978$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.594	$T_j = T_{j\max}$; $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
r_T	On-state slope resistance, max	m Ω	0.640		
I_H	Holding current, max	mA	500	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate open	
BLOCKING					
I_{DRM} , I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j\min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	500 300 150	$T_j = T_{j\min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.40	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$;	
I_{GD}	Gate non-trigger direct current, min	mA	60.00	Direct gate current	
SWITCHING					
t_{gd}	Delay time, max	μ s	1.05	$T_j = 25$ $^{\circ}$ C; $V_D = 1000$ V; $I_{TM} = I_{TAV}$; $di/dt = 200$ A/ μ s;	
t_{gt}	Turn-on time ²⁾ , max	μ s	2.50, 3.20, 4.00, 6.30	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s	
t_q	Turn-off time ³⁾ max	μ s	50.0, 63.0	$dv_D/dt = 50$ V/ μ s	$T_j = T_{j\max}$; $I_{TM} = I_{TAV}$; $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 V_{DRM}$
			63.0, 80.0	$dv_D/dt = 200$ V/ μ s	

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

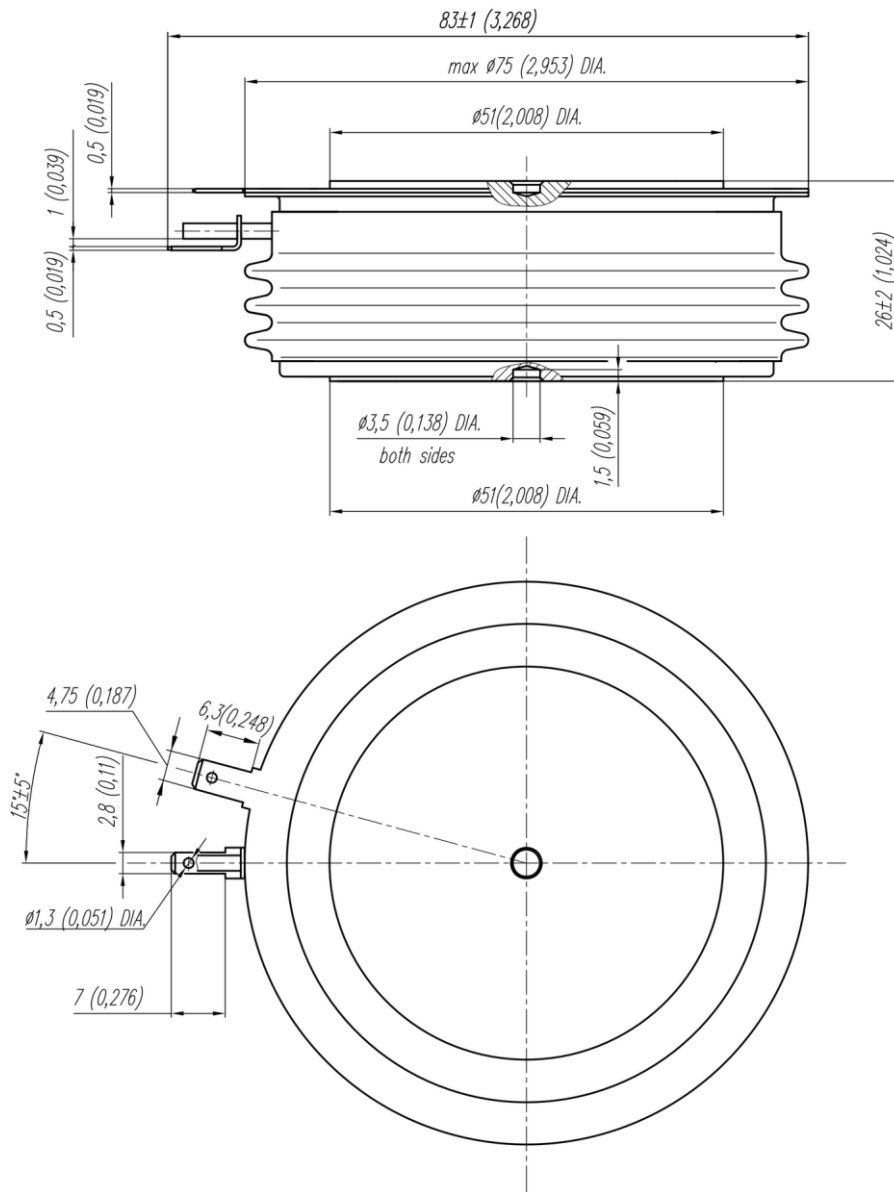
THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0210	Direct current	Double side cooled
R_{thjc-A}			0.0462		Anode side cooled
R_{thjc-K}			0.0378		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0040	Direct current	
MECHANICAL					
w	Weight, max	g	550		
D_s	Surface creepage distance	mm (inch)	29.47 (1.160)		
D_a	Air strike distance	mm (inch)	17.50 (0.689)		

PART NUMBERING GUIDE								NOTES							
FDT	56	630	36	7	5	3									
1	2	3	4	5	6	7		1) Critical rate of rise of off-state voltage							
1. FDT — Fast Disc Thyristor								Symbol of Group							
2. Design version								$(dv_D/dt)_{crit}$, V/ μ S							
3. Mean on-state current, A								200							
4. Voltage code								320							
5. Critical rate of rise of off-state voltage								500							
6. Group of turn-off time ($dv_D/dt=50$ V/ μ s)								1000							
7. Group of turn-on time								1600							
1.								2000							
								2500							
								2) Turn-on time							
								Symbol of group							
								4							
								3							
								2							
								1.5							
								t_{gt} , μ S							
								2.50							
								3.20							
								4.00							
								6.30							
								3) Turn-off time ($dv_D/dt=50$ V/ μ s)							
								Symbol of group							
								5.5							
								5							
								t_d , μ S							
								50.0							
								63.0							

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

OVERALL DIMENSIONS

Package type: T.D2



All dimensions in millimeters (inches)